

LM78LXX Series

3-Terminal Positive Regulators

General Description

The LM78LXX series of three terminal positive regulators is available with several fixed output voltages making them useful in a wide range of applications. When used as a zener diode/resistor combination replacement, the LM78LXX usually results in an effective output impedance improvement of two orders of magnitude, and lower quiescent current. These regulators can provide local on card regulation, eliminating the distribution problems associated with single point regulation. The voltages available allow the LM78LXX to be used in logic systems, instrumentation, HiFi, and other solid state electronic equipment.

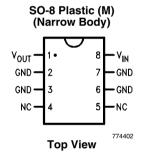
The LM78LXX is available in the plastic TO-92 (Z) package, the plastic SO-8 (M) package and a chip sized package (8-Bump micro SMD) using National's micro SMD package technology. With adequate heat sinking the regulator can deliver 100mA output current. Current limiting is included to limit the peak output current to a safe value. Safe area protection for the output transistors is provided to limit internal power dissi-

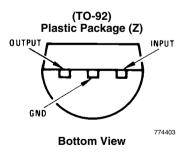
pation. If internal power dissipation becomes too high for the heat sinking provided, the thermal shutdown circuit takes over preventing the IC from overheating.

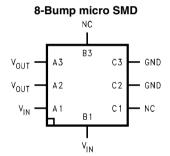
Features

- LM78L05 in micro SMD package
- Output voltage tolerances of ±5% over the temperature range
- Output current of 100mA
- Internal thermal overload protection
- Output transistor safe area protection
- Internal short circuit current limit
- Available in plastic TO-92 and plastic SO-8 low profile packages
- No external components
- Output voltages of 5.0V, 6.2V, 8.2V, 9.0V, 12V, 15V
- See AN-1112 for micro SMD considerations

Connection Diagrams

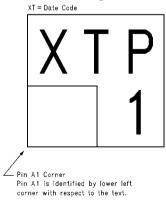






Top View (Bump Side Down)

micro SMD Marking Orientation



Top View

774433

Ordering Information

Package Type	NSC Drawing	Output Voltage	Operating Temperature Range	Order Number	Supplied As
micro SMD	BPA08AAB	5.0V	-40°C to 85°C	LM78L05IBP	OBSOLETE
IIIICIO SIVID	DPAUOAAD	5.00	-40 C to 65 C	LM78L05IBPX	OBSOLETE
		5.0V -40°C to 85°C -		LM78L05ITP	Reel of 250
Thin micro SMD	TPA08AAA	5.00	-40 C to 65 C	LM78L05ITPX	Reel of 3000
THIR HIGG SIMD	IPAUOAAA	9.0V	-40°C to 85°C	LM78L09ITP	OBSOLETE
		9.00	=40 C to 65 C	LM78L09ITPX	Reel of 3000
			0°C to 125°C	LM78L05ACM	Rail of 95
	M08A	5.0V	0 0 10 123 0	LM78L05ACMX	Reel of 2500
			-40°C to 125°C	LM78L05AIM	Rail of 95
SOIC Narrow				LM78L05AIMX	Reel of 2500
SOIC Narrow		12V	0°C to 125°C	LM78L12ACM	Rail of 95
				LM78L12ACMX	Reel of 2500
		45)/	0°C to 125°C	LM78L15ACM	Rail of 95
		15V 0°C to 125°C		LM78L15ACMX	Reel of 2500
		5.0V	0°C to 125°C	LM78L05ACZ	Box of 1800
		6.2V	0°C to 125°C	LM78L62ACZ	Box of 1800
TO-92	Z03A	8.2V	0°C to 125°C	LM78L82ACZ	OBSOLETE
10-92	ZU3A	9.0V	0°C to 125°C	LM78L09ACZ	OBSOLETE
		12V	0°C to 125°C	LM78L12ACZ	Box of 1800
		15V	0°C to 125°C	LM78L15ACZ	Box of 1800

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/ Distributors for availability and specifications.

Power Dissipation (*Note 5*) Internally Limited Input Voltage 35V Storage Temperature -65°C to +150°C ESD Susceptibility (*Note 2*) 1kV

Operating Junction Temperature

 LM78LxxACZ, TO-92
 0°C to 125°C

 LM78LxxACM, SO-8
 0°C to 125°C

 LM78LxxAIM, SO-8
 -40°C to 125°C

 LM78LxxIBPX, micro SMD
 -40°C to 85°C

 LM78LxxITP, Thin micro SMD
 -40°C to 85°C

Soldering Information

Infrared or Convection (20 sec.) 235°C Wave Soldering (10 sec.) 260°C (lead time)

LM78LXX Electrical Characteristics Limits in standard typeface are for T_J = 25°C, **Bold typeface applies** over the entire operating temperature range of the indicated package. Limits are guaranteed by production testing or correlation techniques using standard Statistical Quality Control (SQC) methods. Unless otherwise specified: I_O = 40mA, C_I = 0.33 μ F, C_O = 0.1 μ F.

LM78L05AC / LM78L05I

Unless otherwise specified, $V_{IN} = 10V$

Symbol	Parameter	Conditions	Min	Тур	Max	Units
V _O	Output Voltage		4.8	5	5.2	
		$7V \le V_{IN} \le 20V$ $1mA \le I_O \le 40mA$ (<i>Note 3</i>)	4.75		5.25	V
		$1mA \le I_O \le 70mA$ (<i>Note 3</i>)	4.75		5.25	
ΔV _O	Line Regulation	7V ≤ V _{IN} ≤ 20V		18	75	
		8V ≤ V _{IN} ≤ 20V		10	54] ,,
ΔV _O	Load Regulation	1mA ≤ I _O ≤ 100mA		20	60	- mV -
		1mA ≤ I _O ≤ 40mA		5	30	
I _Q	Quiescent Current	-		3	5	
ΔI _Q	Quiescent Current Change	8V ≤ V _{IN} ≤ 20V			1.0	mA
		1mA ≤ I _O ≤ 40mA			0.1]
V _n	Output Noise Voltage	f = 10 Hz to 100 kHz (<i>Note</i> 4)		40		μV
$\frac{\Delta V_{\text{IN}}}{\Delta V_{\text{OUT}}}$	Ripple Rejection	$f = 120 \text{ Hz}$ $8V \le V_{IN} \le 16V$	47	62		dB
I _{PK}	Peak Output Current			140		mA
$\frac{\Delta V_{O}}{\Delta T}$	Average Output Voltage Tempco	I _O = 5mA		-0.65		mV/°C
V _{IN} (Min)	Minimum Value of Input Voltage Required to Maintain Line Regulation			6.7	7	V
θ_{JA}	Thermal Resistance (8-Bump micro SMD)			230.9		°C/W

LM78L62AC

Unless otherwise specified, $V_{IN} = 12V$

Symbol	Parameter	Conditions	Min	Тур	Max	Units
V _O	Output Voltage		5.95	6.2	6.45	
		8.5V ≤ V _{IN} ≤ 20V				
		1mA ≤ I _O ≤ 40mA	5.9		6.5	V
		(Note 3)				ľ
		1mA ≤ I _O ≤ 70mA	5.9		6.5	
		(Note 3)	5.9		6.5	
ΔV_{O}	Line Regulation	$8.5V \le V_{IN} \le 20V$		65	175	
		9V ≤ V _{IN} ≤ 20V		55	125	.,
ΔV _O	Load Regulation	ad Regulation 1mA ≤ I _O ≤ 100mA		13	80	mV
		1mA ≤ I _O ≤ 40mA		6	40	
I _Q	Quiescent Current			2	5.5	
Δl _Q	Quiescent Current Change	8V ≤ V _{IN} ≤ 20V			1.5	mA
		1mA ≤ I _O ≤ 40mA			0.1	
V _n	Output Noise Voltage	f = 10 Hz to 100 kHz		50		/
		(Note 4)		30		μV
ΔV_{IN}	Ripple Rejection	f = 120 Hz	40	46		l dB
ΔV _{OUT}		$10V \le V_{\rm IN} \le 20V$	1 40	40		ub
I_{PK}	Peak Output Current			140		mA
ΔV_{O}	Average Output Voltage Tempco	$I_O = 5mA$		-0.75		mV/°C
ΔΤ				-0.73		11117/ 0
V _{IN} (Min)	Minimum Value of Input Voltage			7.9		V
	Required to Maintain Line Regulation					

LM78L82AC

Unless otherwise specified, $V_{IN} = 14V$

Symbol	Parameter	Conditions	Min	Тур	Max	Units
V _O	Output Voltage		7.87	8.2	8.53	
		11V ≤ V _{IN} ≤ 23V				
		1mA ≤ I _O ≤ 40mA	7.8		8.6	V
		(Note 3)				ľ
		1mA ≤ I _O ≤ 70mA	7.8		8.6	
		(Note 3)	7.0		0.0	
ΔV_{O}	Line Regulation	$11V \le V_{IN} \le 23V$		80	175	mV
		$12V \le V_{IN} \le 23V$		70 1:	125	
ΔV _O	Load Regulation	1mA ≤ I _O ≤ 100mA		15	80	
		1mA ≤ I _O ≤ 40mA		8	40	
I _Q	Quiescent Current			2	5.5	
ΔI_Q	Quiescent Current Change	12V ≤ V _{IN} ≤ 23V			1.5	mA
		1mA ≤ I _O ≤ 40mA			0.1	
V _n	Output Noise Voltage	Voltage f = 10 Hz to 100 kHz		60		\/
		(Note 4)		- 00		μV
ΔV_{IN}	Ripple Rejection	f = 120 Hz	39	45		dB
ΔV _{OUT}		$12V \le V_{IN} \le 22V$	39	40		ub
I _{PK}	Peak Output Current			140		mA

Symbol	Parameter	Conditions	Min	Тур	Max	Units
$\frac{\Delta V_{O}}{\Delta T}$	Average Output Voltage Tempco	I _O = 5mA		-0.8		mV/°C
V _{IN} (Min)	Minimum Value of Input Voltage Required to Maintain Line Regulation			9.9		V

LM78L09AC / LM78L09I

Unless otherwise specified, $V_{IN} = 15V$

Symbol	Parameter	Conditions	Min	Тур	Max	Units
V_{o}	Output Voltage		8.64	9.0	9.36	
		$11.5V \le V_{IN} \le 24V$				
		$1mA \le I_O \le 40mA$ (<i>Note 3</i>)	8.55		9.45	V
		$1mA \le I_O \le 70mA$ (<i>Note 3</i>)	8.55		9.45	
ΔV_{O}	Line Regulation	11.5V ≤ V _{IN} ≤ 24V		100	200	
		$13V \le V_{IN} \le 24V$		90	150	mV
ΔV_{O}	Load Regulation	1mA ≤ I _O ≤ 100mA		20	90	
		1mA ≤ I _O ≤ 40mA		10	45	
IQ	Quiescent Current			2	5.5	
ΔI_Q	Quiescent Current Change	$11.5V \le V_{IN} \le 24V$			1.5	mA
		1mA ≤ I _O ≤ 40mA			0.1	
V _n	Output Noise Voltage			70		μV
$\frac{\Delta V_{IN}}{\Delta V_{OUT}}$	Ripple Rejection	$f = 120 \text{ Hz}$ $15 \text{V} \le \text{V}_{\text{IN}} \le 25 \text{V}$	38	44		dB
I _{PK}	Peak Output Current			140		mA
$\frac{\Delta V_{O}}{\Delta T}$	Average Output Voltage Tempco	I _O = 5mA		-0.9		mV/°C
V _{IN} (Min)	Minimum Value of Input Voltage Required to Maintain Line Regulation			10.7		V

LM78L12AC

Unless otherwise specified, $V_{IN} = 19V$

Symbol	Parameter	Conditions	Min	Тур	Max	Units
V _O	Output Voltage		11.5	12	12.5	
		$14.5 \text{V} \leq \text{V}_{\text{IN}} \leq 27 \text{V}$ $1 \text{mA} \leq \text{I}_{\text{O}} \leq 40 \text{mA}$ $(\textit{Note 3})$	11.4		12.6	V
		$1mA \le I_O \le 70mA$ (<i>Note 3</i>)	11.4		12.6	
ΔV _O	Line Regulation	14.5V ≤ V _{IN} ≤ 27V		30	180	
		16V ≤ V _{IN} ≤ 27V		20	110	mV
ΔV _O	Load Regulation	1mA ≤ I _O ≤ 100mA		30	100	_ IIIV
		1mA ≤ I _O ≤ 40mA		10	50	
Q	Quiescent Current			3	5	
71 ^d	Quiescent Current Change	16V ≤ V _{IN} ≤ 27V			1	mA
		1mA ≤ I _O ≤ 40mA			0.1]
V _n	Output Noise Voltage			80		μV

Symbol	Parameter	Conditions	Min	Тур	Max	Units
$\frac{\Delta V_{\text{IN}}}{\Delta V_{\text{OUT}}}$	Ripple Rejection	f = 120 Hz 15V ≤ V _{IN} ≤ 25	40	54		dB
I _{PK}	Peak Output Current			140		mA
$\frac{\Delta V_{O}}{\Delta T}$	Average Output Voltage Tempco	I _O = 5mA		-1.0		mV/°C
V _{IN} (Min)	Minimum Value of Input Voltage Required to Maintain Line Regulation			13.7	14.5	V

LM78L15AC

Unless otherwise specified, $V_{IN} = 23V$

Symbol	Parameter	Conditions	Min	Тур	Max	Units
$\overline{V_0}$	Output Voltage		14.4	15.0	15.6	
		$17.5V \le V_{IN} \le 30V$ $1mA \le I_O \le 40mA$ (<i>Note 3</i>)	14.25		15.75	V
		$1mA \le I_O \le 70mA$ (<i>Note 3</i>)	14.25		15.75	
ΔV_{O}	Line Regulation	17.5V ≤ V _{IN} ≤ 30V		37	250	
		20V ≤ V _{IN} ≤ 30V		25	140	mV
ΔV_{O}	Load Regulation	1mA ≤ I _O ≤ 100mA		35	150	
		1mA ≤ I _O ≤ 40mA		12	75	
I _Q	Quiescent Current			3	5	
ΔI _Q	Quiescent Current Change	$20V \le V_{IN} \le 30V$			1	mA
		1mA ≤ I _O ≤ 40mA			0.1	
V _n	Output Noise Voltage			90		μV
$\frac{\Delta V_{\text{IN}}}{\Delta V_{\text{OUT}}}$	Ripple Rejection	f = 120 Hz 18.5V \leq V _{IN} \leq 28.5V	37	51		dB
I _{PK}	Peak Output Current			140		mA
$\frac{\Delta V_{O}}{\Delta T}$	Average Output Voltage Tempco	I _O = 5mA		-1.3		mV/°C
V _{IN} (Min)	Minimum Value of Input Voltage Required to Maintain Line Regulation			16.7	17.5	V

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Electrical specifications do not apply when operating the device outside of its stated operating conditions.

Note 2: Human body model, 1.5 k Ω in series with 100pF.

Note 3: Power dissipation ≤ 0.75 W.

Note 4: Recommended minimum load capacitance of $0.01\mu\text{F}$ to limit high frequency noise.

Note 5: Typical thermal resistance values for the packages are:

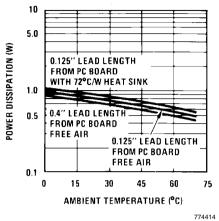
Z Package: θ_{JC} = 60 °C/W, = θ_{JA} = 230 °C/W

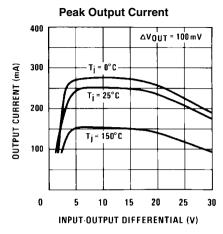
M Package: θ_{JA} = 180 °C/W

micro SMD Package: $\theta_{JA} = 230.9^{\circ}C/W$

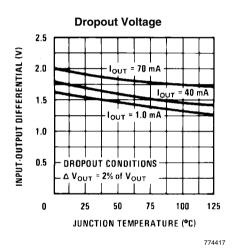
Typical Performance Characteristics

Maximum Average Power Dissipation (Z Package)



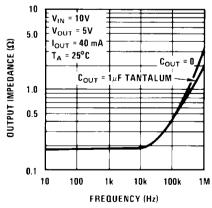


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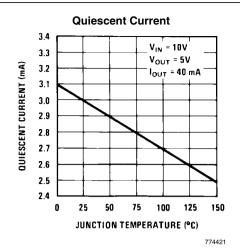


Ripple Rejection 100 80 RIPPLE REJECTION (dB) 60 VIN = 10V V_{OUT} = 5V 20 I_{OUT} = 40 mA = 25°C n 10 100 10k 1k 100k FREQUENCY (Hz) 774418

Output Impedance



Quiescent Current 4.0 3.8 QUIESCENT CURRENT (mA) 3.6 3.4 3.2 3.0 2.8 2.6 V_{OUT} = 5V 2.4 I_{OUT} = 40 mA 2.2 T_J = 25°C 15 20 25 30 INPUT VOLTAGE (V) 774420

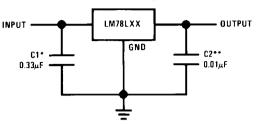


Equivalent Circuit

LM78LXX Q16 Q10 015 R15 ₹ R16 R10 2.5k **≸** R12 **1**01 **1**02 Q7 R13 **₹** 2 23k R6 2.84k 774407

Typical Applications

Fixed Output Regulator

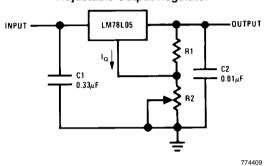


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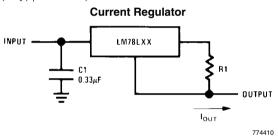
*Required if the regulator is located more than 3 from the power supply filter.

**See (Note 4) in the electrical characteristics table.

Adjustable Output Regulator

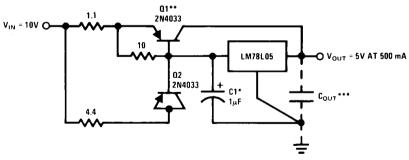


 V_{OUT} = 5V + (5V/R1 + I_Q) R2 5V/R1 > 3 I_Q , load regulation (L_r) ≈ [(R1 + R2)/R1] (L_r of LM78L05)



 $I_{OUT} = (V_{OUT}/R1) + I_{Q}$ > $I_{Q} = 1.5$ mA over line and load changes

5V, 500mA Regulator with Short Circuit Protection



774411

Load Regulation: 0.6% 0 \leq I_L \leq 250mA pulsed with t_{ON} = 50ms.

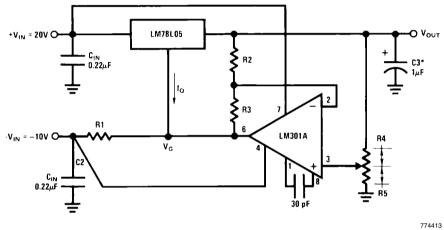
^{*}Solid tantalum.

^{**}Heat sink Q1.

 $[\]ensuremath{^{***}}\xspace$ Optional: Improves ripple rejection and transient response.

*Solid tantalum.

Variable Output Regulator 0.5V-18V



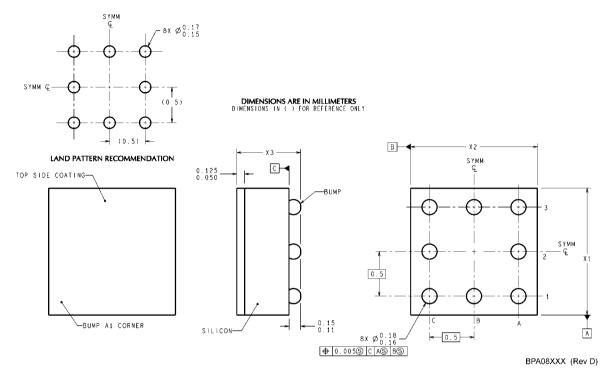
*Solid tantalum.

 $V_{OUT} = V_{G} + 5V, R1 = (-V_{IN}/I_{Q LM78L05})$

 $V_{OUT} = 5V (R2/R4) \text{ for } (R2 + R3) = (R4 + R5)$

A 0.5V output will correspond to (R2/R4) = 0.1 (R3/R4) = 0.9

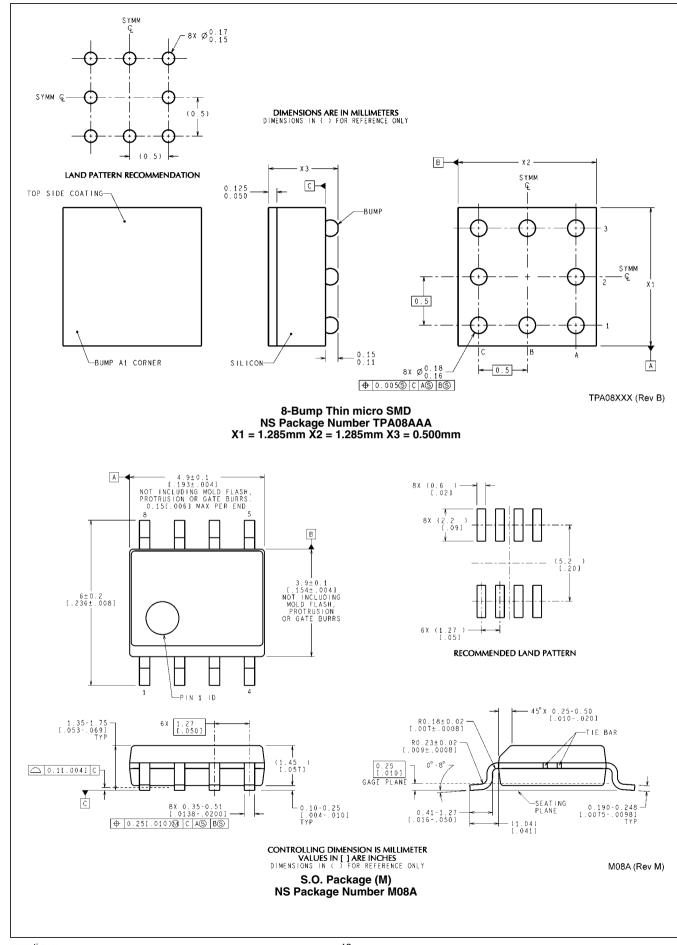
Physical Dimensions inches (millimeters) unless otherwise noted

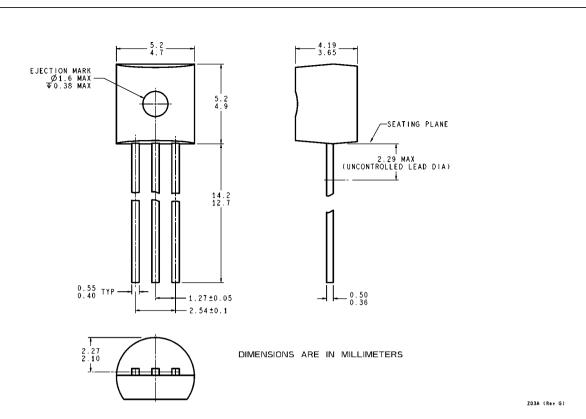


NOTES: UNLESS OTHERWISE SPECIFIED

- 1. EPOXY COATING
- 2. 63Sn/37Pb EUTECTIC BUMP
- 3. RECOMMEND NON-SOLDER MASK DEFINED LANDING PAD.
- 4. PIN A1 IS ESTABLISHED BY LOWER LEFT CORNER WITH RESPECT TO TEXT ORIENTATION. REMAINING PINS ARE NUMBERED COUNTERCLOCKWISE.
- $5. \, \rm XXX$ IN DRAWING NUMBER REPRESENTS PACKAGE SIZE VARIATION WHERE $\rm X_1$ IS PACKAGE WIDTH, $\rm X_2$ IS PACKAGE LENGTH AND $\rm X_3$ IS PACKAGE HEIGHT.
- 6. REFERENCE JEDEC REGISTRATION MO-211, VARIATION BC.

8-Bump micro SMD NS Package Number BPA08AAB X1 = 1.285mm X2 = 1.285mm X3 = 0.850mm





Molded Offset TO-92 (Z) NS Package Number Z03A

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